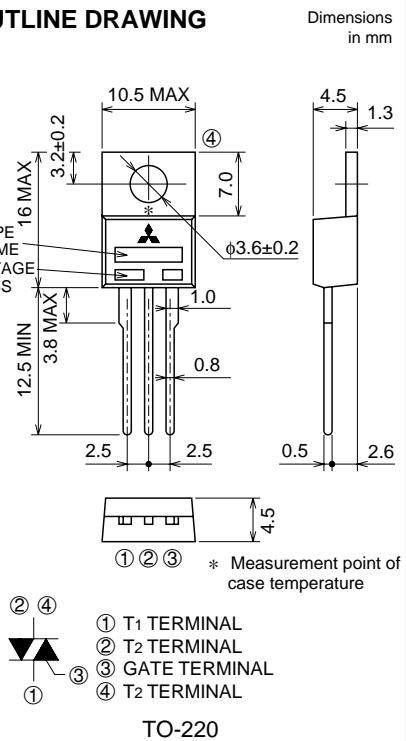


**BCR10CM**MEDIUM POWER USE  
NON-INSULATED TYPE, PLANAR PASSIVATION TYPE**BCR10CM**

- **IT (RMS) .....** 10A
- **VDRM .....** 400V/600V
- **IFGT I , IRGT I , IRGT III .....** 30mA (20mA) \*5

**OUTLINE DRAWING****APPLICATION**

Contactless AC switches, light dimmer, electric flasher unit, control of household equipment such as TV sets · stereo · refrigerator · washing machine · infrared kotatsu · carpet · electric fan, solenoid drivers, small motor control, copying machine, electric tool, other general purpose control applications

**MAXIMUM RATINGS**

Symbol	Parameter	Voltage class		Unit
		8	12	
V <sub>DRM</sub>	Repetitive peak off-state voltage *1	400	600	V
V <sub>DSD</sub>	Non-repetitive peak off-state voltage *1	500	720	V

Symbol	Parameter	Conditions	Ratings	Unit
I <sub>T</sub> (RMS)	RMS on-state current	Commercial frequency, sine full wave 360° conduction, T <sub>c</sub> =103°C	10	A
I <sub>TSM</sub>	Surge on-state current	60Hz sinewave 1 full cycle, peak value, non-repetitive	100	A
I <sup>2</sup> t	I <sup>2</sup> t for fusing	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current	41.6	A <sup>2</sup> s
P <sub>GM</sub>	Peak gate power dissipation		5	W
P <sub>G(AV)</sub>	Average gate power dissipation		0.5	W
V <sub>GM</sub>	Peak gate voltage		10	V
I <sub>GM</sub>	Peak gate current		2	A
T <sub>j</sub>	Junction temperature		-40 ~ +125	°C
T <sub>stg</sub>	Storage temperature		-40 ~ +125	°C
—	Weight	Typical value	2.0	g

\*1. Gate open.

Feb.1999

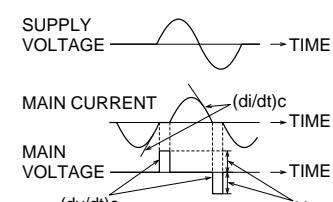
## ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
I <sub>DRM</sub>	Repetitive peak off-state current	T <sub>j</sub> =125°C, V <sub>DRM</sub> applied	—	—	2.0	mA
V <sub>TM</sub>	On-state voltage	T <sub>c</sub> =25°C, I <sub>TM</sub> =15A, Instantaneous measurement	—	—	1.5	V
V <sub>FGBT</sub> I	Gate trigger voltage *2	I	T <sub>j</sub> =25°C, V <sub>d</sub> =6V, R <sub>L</sub> =6Ω, R <sub>G</sub> =330Ω	—	—	1.5
V <sub>RGTR</sub> I		II		—	—	1.5
V <sub>RGTR</sub> III		III		—	—	1.5
I <sub>FGBT</sub> I	Gate trigger current *2	I	T <sub>j</sub> =25°C, V <sub>d</sub> =6V, R <sub>L</sub> =6Ω, R <sub>G</sub> =330Ω	—	—	30*5 mA
I <sub>RGTR</sub> I		II		—	—	30*5 mA
I <sub>RGTR</sub> III		III		—	—	30*5 mA
V <sub>GD</sub>	Gate non-trigger voltage	T <sub>j</sub> =125°C, V <sub>d</sub> =1/2V <sub>DRM</sub>	0.2	—	—	V
R <sub>th</sub> (j-c)	Thermal resistance	Junction to case *4	—	—	1.8	°C/W
(d <sub>v</sub> /dt) <sub>c</sub>	Critical-rate of rise of off-state commuting voltage		*3	—	—	V/μs

\*2. Measurement using the gate trigger characteristics measurement circuit.

\*3. The critical-rate of rise of the off-state commuting voltage is shown in the table below.

\*4. The contact thermal resistance R<sub>th</sub> (c-f) in case of greasing is 1.0°C/W.\*5. High sensitivity (I<sub>GT</sub>≤20mA) is also available. (IGT item ①)

Voltage class	V <sub>DRM</sub> (V)	(d <sub>v</sub> /dt) <sub>c</sub>			Test conditions	Commutating voltage and current waveforms (inductive load)
		Symbol	Min.	Unit		
8	400	R	—	V/μs	1. Junction temperature T <sub>j</sub> =125°C 2. Rate of decay of on-state commuting current (d <sub>i</sub> /dt) <sub>c</sub> =-5A/ms 3. Peak off-state voltage V <sub>d</sub> =400V	
		L	10			
12	600	R	—			
		L	10			

## PERFORMANCE CURVES

